



Atty. Dkt. No. 047071-0107

**THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Harry A. ATWATER, Jr. et al.

Title: WAFER BONDED VIRTUAL SUBSTRATE AND  
METHOD FOR FORMING THE SAME

Appl. No.: 10/761,918

OK to

Filing Date: 1/20/2004

enter (29)

Examiner: Duy-Vu DEO

Art Unit: 1765

Confirmation 4108

Number:

**AMENDMENT AND REPLY UNDER 37 CFR 1.116**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This communication is responsive to the Final Office Action dated November 7, 2006, concerning the above-referenced patent application.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this document.

**Remarks/Arguments** begin on page 5 of this document.

Please amend the application as follows: